

Photocoupler LTV-8x5 series

1. DESCRIPTION

1.1 Features

- Current transfer ratio (CTR : MIN. 600% at I_F = 1mA, V_{CE} = 2V)
- High input-output isolation voltage (V_{iso} = 5,000Vrms)
- $\blacksquare~$ Response time (tr : TYP. 60µs at V_{CE} = 2V, I_C = 10mA, R_L = 100\Omega)
- Dual-in-line package :

LTV-815 : 1-channel type

LTV-825 : 2-channel type LTV-845 : 4-channel type

Wide lead spacing package :

LTV-815M : 1-channel type

LTV-825M : 2-channel type

LTV-845M : 4-channel type

Surface mounting package :

LTV-815S : 1-channel type

LTV-825S : 2-channel type

- LTV-845S : 4-channel type
- Tape and reel packaging :

LTV-815S-TA : 1-channel type

- LTV-815S-TA1 : 1-channel type
- LTV-815S-TP : 1-channel type
- LTV-825S-TA1 : 2-channel type
- Safety approval

UL 1577

VDE DIN EN60747-5-5 (VDE 0884-5)

CSA CA5A

Nordic Safety (FIMKO/NEMKO/SEMKO/DEMKO)

■ BSI RoHS Compliance

All materials be used in device are followed EU RoHS directive (No.2002/95/EC).

- ESD pass HBM 8000V/MM2000V
- MSL class1

1.2 Applications

- Hybrid substrates that require high density mounting.
- Programmable controllers

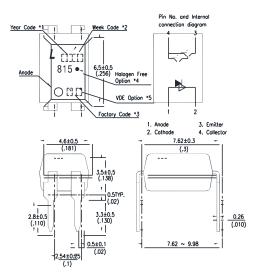
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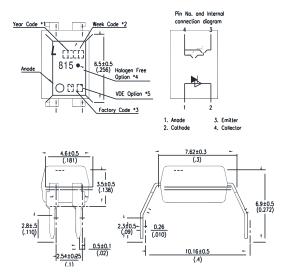
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2. PACKAGE DIMENSIONS

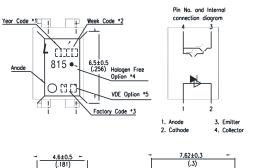
2.1 LTV-815

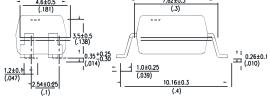


2.2 LTV-815M



2.3 LTV-815S





Notes :

- 1. Year date code.
- 2. 2-digit work week.
- Factory identification mark shall be marked (W: China-CZ, Y: Thailand)
- 4. Rank shall be or shall not be marked.
- 5. "●" for halogen free option.
- 6. "4" or" V" for VDE option.

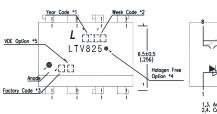
Dimensions in millimeters(inches).

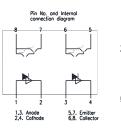
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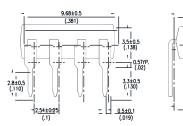


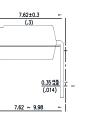
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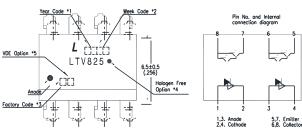
2.4 LTV-825

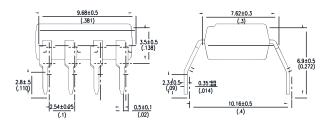




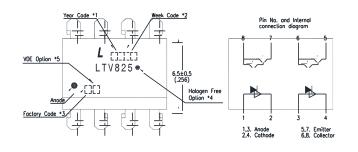


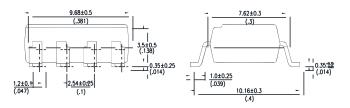






2.6 LTV-825S





Notes :

2.5 LTV-825M

- 1. Year date code.
- 2. 2-digit work week.
- Factory identification mark shall be marked (W: China-CZ, Y: Thailand)
- 4. Rank shall be or shall not be marked.
- 5. "
 for halogen free option.
- 6. VDE option shall be

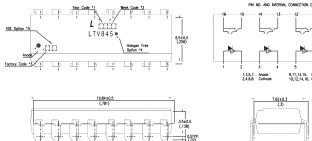
Dimensions in millimeters(inches).

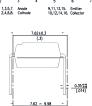
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2.7 LTV-845



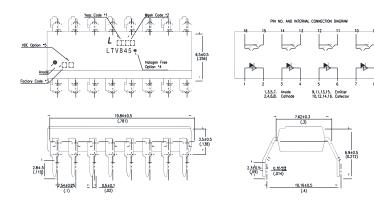


2.8 LTV-845M

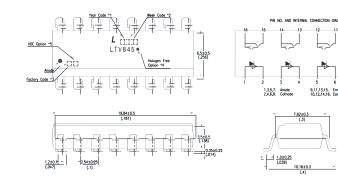
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 $\frac{0.5\pm0.1}{(02)}$

2.8±0.5 (.110)

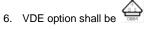


2.9 LTV-845S



Notes :

- Year date code. 1.
- 2. 2-digit work week.
- Factory identification mark shall be marked 3. (W: China-CZ, Y: Thailand)
- Rank shall be or shall not be marked. 4.
- for halogen free option. 5.



Dimensions in millimeters(inches).

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10.35:22 (.014)

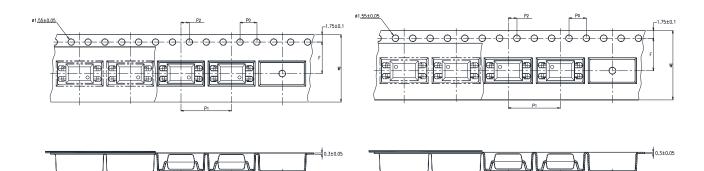


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3. TAPING DIMENSIONS

3.1 LTV-815S-TA

3.2 LTV-815S-TA1



Description	Symbol	Dimension in mm (inch)
Tape wide	W	16±0.3 (0.63)
Pitch of sprocket holes	Po	4±0.1 (0.15)
Distance of compartment	F	7.5±0.1 (0.295)
Distance of compartment	P ₂	2±0.1 (0.079)
Distance of compartment to compartment	P ₁	12±0.1 (0.472)

3.3 Quantities Per Reel

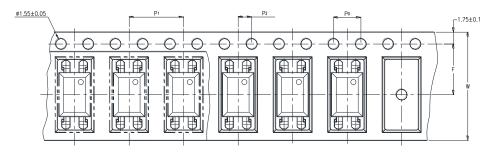
Package Type	TA/TA1
Quantities (pcs)	1000

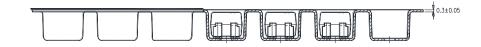




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3.4 LTV-815S-TP





Description	Symbol	Dimension in mm (inch)
Tape wide	W	16±0.3 (0.63)
Pitch of sprocket holes	P ₀	4±0.1 (0.15)
Distance of compartment	F	7.5±0.1 (0.295)
Distance of compartment	P ₂	2±0.1 (0.079)
Distance of compartment to compartment	P ₁	8±0.1 (0.472)

3.5 Quantities Per Reel

Package Type	ТР
Quantities (pcs)	2000

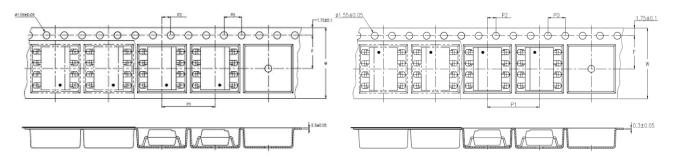




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3.6 LTV-825S-TA

3.7 LTV-825S-TA1



Description	Symbol	Dimension in mm (inch)
Tape wide	W	16±0.3 (0.63)
Pitch of sprocket holes	Po	4±0.1 (0.15)
Distance of compartment	F	7.5±0.1 (0.295)
Distance of compartment	P ₂	2±0.1 (0.079)
Distance of compartment to compartment	P ₁	12±0.1 (0.472)

3.8 Quantities Per Reel

Package Type	TA/TA1
Quantities (pcs)	1000

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4. RATING AND CHARACTERISTICS

4.1 Absolute Maximum Ratings at Ta=25°C

	Parameter	Symbol	Rating	Unit
	Forward Current	I _F	50	mA
Input	Reverse Voltage	V _R	6	V
	Power Dissipation	Р	70	mW
	Collector - Emitter Voltage	V _{CEO}	35	V
Outrust	Emitter - Collector Voltage	V _{ECO}	6	V
Output	Collector Current	Ι _C	80	mA
	Collector Power Dissipation	Pc	150	mW
	Total Power Dissipation	P _{tot}	200	mW
1.	Isolation Voltage	V _{iso}	5000	V _{rms}
	Operating Temperature	T _{opr}	-30 ~ +110	°C
	Storage Temperature	T _{stg}	-55 ~ +125	°C
2	Soldering Temperature	T _{sol}	260	°C

- 1. AC For 1 Minute, R.H. = 40 ~ 60%
 - Isolation voltage shall be measured using the following method.
 - Short between anode and cathode on the primary side and between collector and emitter on the secondary side.
 - (2) The isolation voltage tester with zero-cross circuit shall be used.
 - (3) The waveform of applied voltage shall be a sine wave.
- 2. For 10 Seconds

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4.2 ELECTRICAL OPTICAL CHARACTERISTICS at Ta=25°C

F	Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition
	Forward Voltage	V _F	-	1.2	1.4	V	I _F =±20mA
Input	Reverse Current	I _R	_	_	10	μΑ	V _R =4V
	Terminal Capacitance	Ct	_	30	250	pF	V=0, f=1KHz
	Collector Dark Current	I _{CEO}	_	_	1	μΑ	V_{CE} =10V, I _F =0
Output	Collector-Emitter Breakdown Voltage	BV _{CEO}	35	_	_	V	I _C =0.1mA, I _F =0
	Emitter-Collector Breakdown Voltage	BV _{ECO}	6	_	_	V	I _E =10μΑ, I _F =0
-	Collector Current	Ι _C	6	—	75	mA	
	1. Current Transfer Ratio	CTR	600	—	7500	%	I _F =1mA, V _{CE} =2V
	Collector-Emitter Saturation Voltage	V _{CE(sat)}	_	0.8	1	V	I _F =20mA, I _C =5mA
TRANSFER	Isolation Resistance	R _{iso}	5×10 ¹⁰	1×10 ¹¹	_	Ω	DC500V, 40 ~ 60% R.H.
CHARACTERISTICS	Floating Capacitance	Cf	_	0.6	1	pF	V=0, f=1MHz
	Cut-off Frequency	f _c	1	6		kHz	V_{CE} =5V, I _C =2mA R _L =100 Ω ,-3dB
	Response Time (Rise)	tr	_	60	300	μS	V _{CE} =2V, I _C =10mA
	Response Time (Fall)	tf	_	53	250	μs	R _L =100Ω,

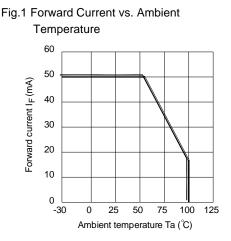
1. CTR =
$$\frac{I_{C}}{I_{F}} \times 100\%$$

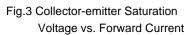
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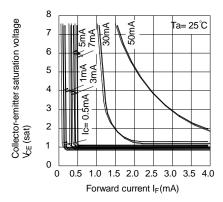


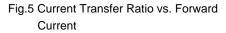
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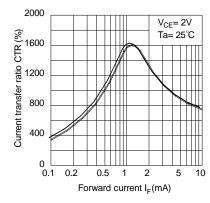
5. CHARACTERISTICS CURVES

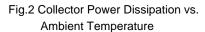












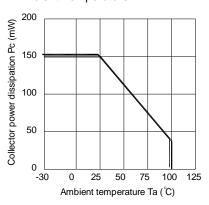


Fig.4 Forward Current vs. Forward Voltage

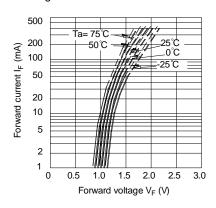
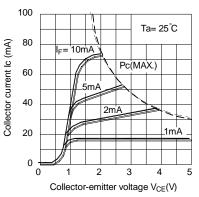


Fig.6 Collector Current vs.

Collector-emitter Voltage



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vs. Ambient Temperature 150 160 1F= 1mA VCE= 2V 100 50 0 0 0 0 25 50 75 100Ambient temperature Ta (°C)

Fig.7 Relative Current Transfer Ratio

Fig.9 Collector Dark Current vs. Ambient Temperature

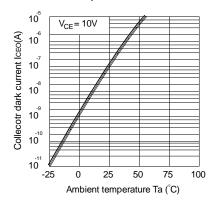


Fig.11 Frequency Response

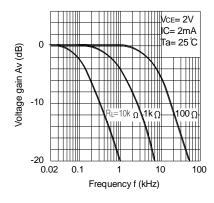
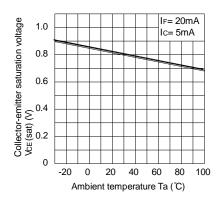
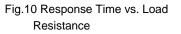
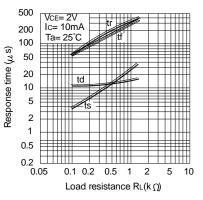


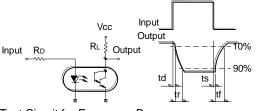
Fig.8 Collector-emitter Saturation Voltage vs. Ambient Temperature



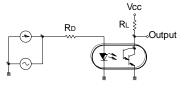












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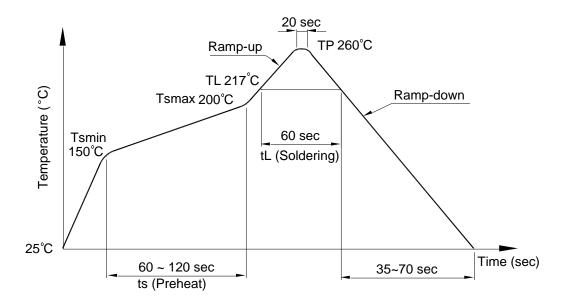
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6. TEMPERATURE PROFILE OF SOLDERING

6.1 IR Reflow soldering (JEDEC-STD-020C compliant)

One time soldering reflow is recommended within the condition of temperature and time profile shown below. Do not solder more than three times.

Profile item	Conditions		
Preheat			
- Temperature Min (T _{Smin})	150°C		
- Temperature Max (T _{Smax})	200°C		
- Time (min to max) (ts)	90±30 sec		
Soldering zone			
- Temperature (T_L)	217°C		
- Time (t_L)	60 sec		
Peak Temperature (T _P)	260°C		
Ramp-up rate	3°C / sec max.		
Ramp-down rate	3~6°C / sec		



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6.2 Wave soldering (JEDEC22A111 compliant)

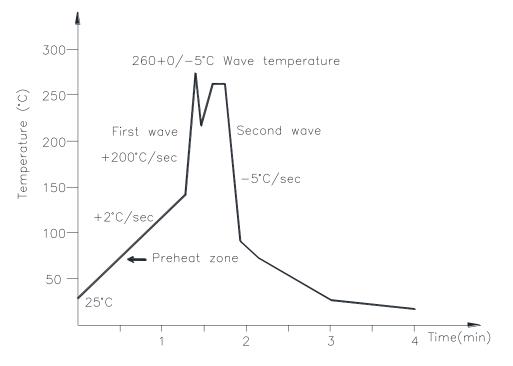
One time soldering is recommended within the condition of temperature.

Temperature: 260+0/-5°C

Time: 10 sec.

Preheat temperature:25 to 140°C

Preheat time: 30 to 80 sec.



6.3 Hand soldering by soldering iron

Allow single lead soldering in every single process. One time soldering is recommended.

Temperature: 380+0/-5°C

Time: 3 sec max.

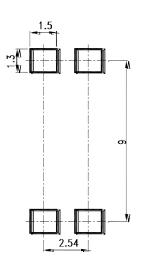
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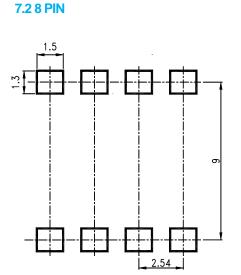


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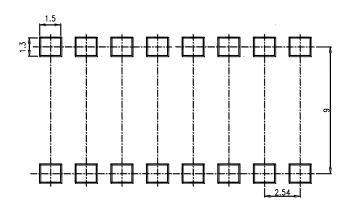
7. RRECOMMENDED FOOT PRINT PATTERNS (MOUNT PAD)

7.1 4 PIN





7.3 16PIN



Note :

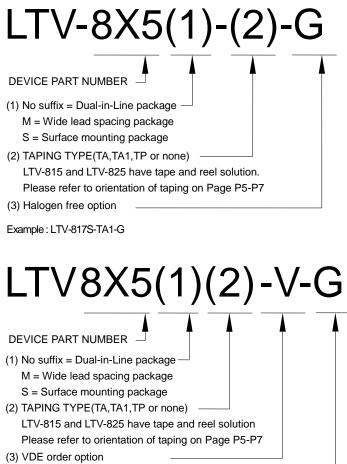
Dimensions in millimeters.

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8. Naming rule



(4) Halogen free option

Example : LTV815STA1-V-G

9. Notes:

- LiteOn is continually improving the quality, reliability, function or design and LiteOn reserves the right to make changes without further notices.
- The products shown in this publication are designed for the general use in electronic applications such as office automation equipment, communications devices, audio/visual equipment, electrical application and instrumentation.
- For equipment/devices where high reliability or safety is required, such as space applications, nuclear power control equipment, medical equipment, etc, please contact our sales representatives.
- When requiring a device for any "specific" application, please contact our sales in advice.
- If there are any questions about the contents of this publication, please contact us at your convenience.
- The contents described herein are subject to change without prior notice.
- Immerge unit's body in solder paste is not recommended.

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